

PNZ120S (PN120S)

Silicon planar type

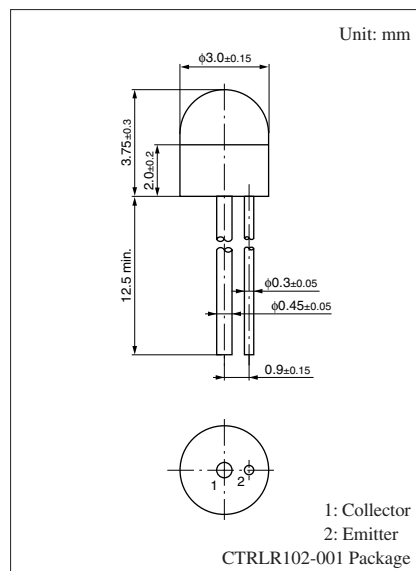
For optical control systems

■ Features

- High sensitivity
- Wide directivity characteristics for easy use
- Fast response: $t_r, t_f = 3 \mu s$ (typ.)
- Signal mixing capability using base pin
- Small size ($\phi 3$) ceramic package

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Collector-emitter voltage (Base open)	V_{CEO}	30	V
Emitter-collector voltage (Base open)	V_{ECO}	5	V
Collector current	I_C	20	mA
Collector power dissipation	P_C	50	mW
Operating ambient temperature	T_{opr}	-25 to +85	$^\circ C$
Storage temperature	T_{stg}	-30 to +100	$^\circ C$



■ Electrical-Optical Characteristics $T_a = 25^\circ C \pm 3^\circ C$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Photocurrent *1, *2	$I_{CE(L)1}$	$V_{CE} = 10 V, L = 2 lx$	3			μA
	$I_{CE(L)2}$	$V_{CE} = 10 V, L = 500 lx$	1.0			mA
Dark current	I_{CEO}	$V_{CE} = 10 V$		5	500	nA
Peak emission wavelength	λ_p	$V_{CE} = 10 V$		800		nm
Half-power angle	θ	The angle from which photocurrent becomes 50%		50		$^\circ$
Rise time *3	t_r	$V_{CC} = 10 V, I_{CE(L)} = 5 mA, R_L = 100 \Omega$		3		μs
Fall time *3	t_f			3		μs
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_{CE(L)} = 1 mA, L = 1000 lx$		0.2	0.5	V

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.

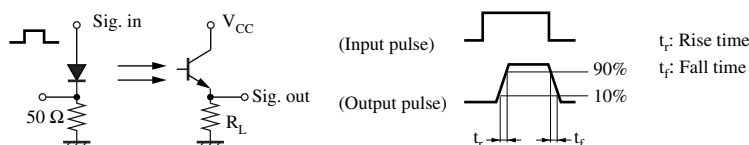
3. This device is designed be disregarded radiation.

5. *1: Source: Tungsten (color temperature 2856 K)

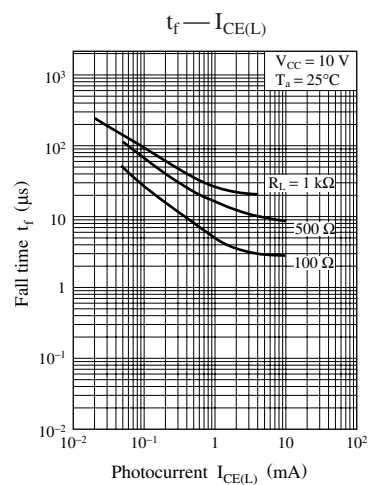
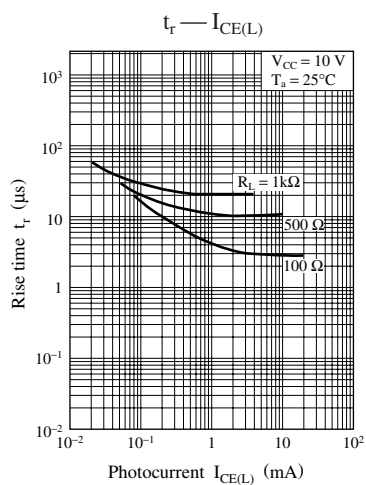
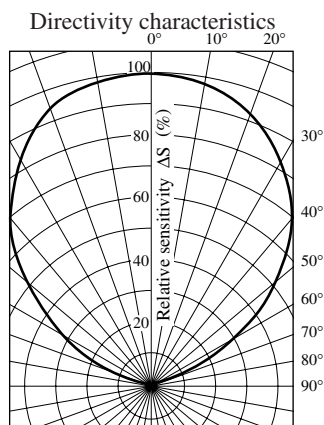
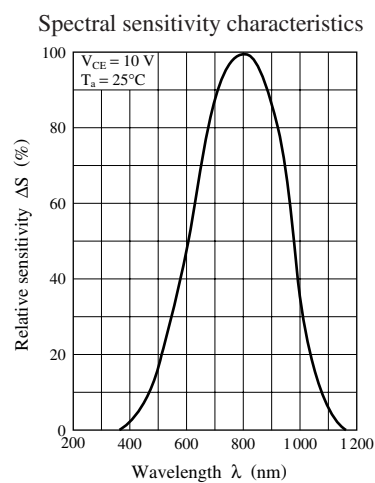
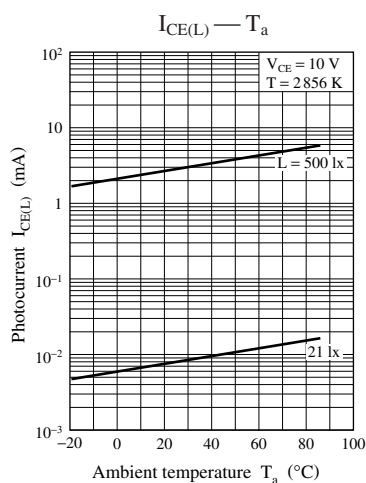
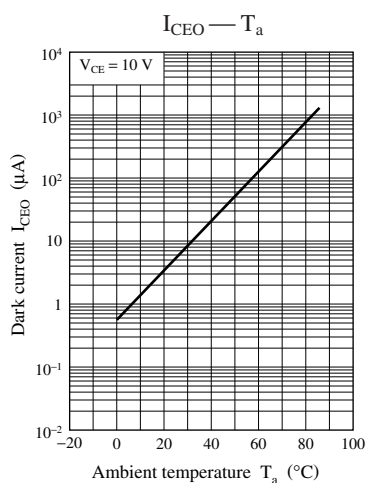
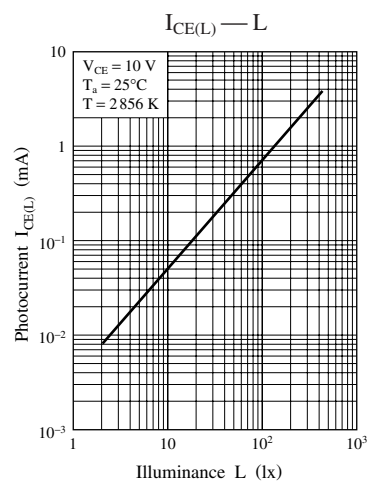
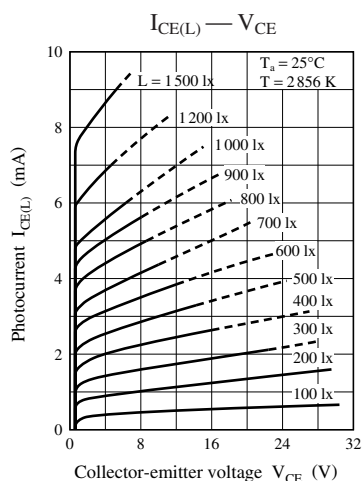
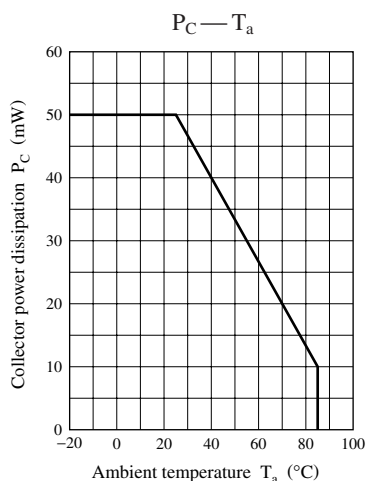
*2: Rank classification

Rank	QL	RL	SL	Q	R	S
$I_{CE(L)1}$	3 to 16	10 to 30	>24	—	—	—
$I_{CE(L)2}$	5 typ.	6 typ.	8 typ.	1.0 to 5.0	4.0 to 9.0	>7.0

*3: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.



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